

# Part Number: XZMOLA92S-4

3.5x3.5 mm SMD CHIP LED LAMP

#### **Features**

• Ideal for indication light on hand held products

• Long life and robust package

• Variety of lens types and color choices available

• ESD protection

• Package: 2000pcs / reel

Moisture sensitivity level: level 2a

• RoHS compliant







ATTENTION

OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

# **Application Note**

Static electricity and surge damage the LEDS.

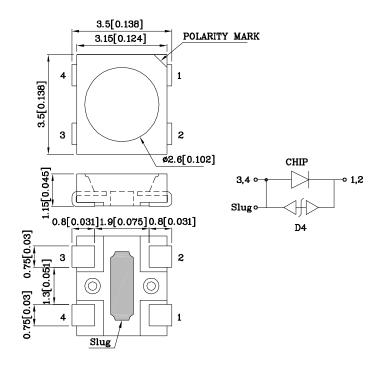
It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

# **Applications**

- Signal and symbol luminaire for orientation.
- Marker lights (e.g. steps, exit ways, etc).
- Decorative and entertainment lighting.
- Commercial and residential lighting.
- Automotive interior lighting.

# **Package Schematics**



#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25(0.01")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

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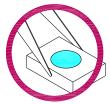


### **Handling Precautions**

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

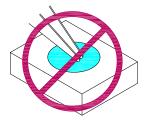
As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.

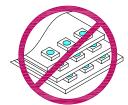


2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

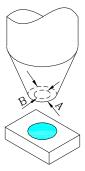




3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4.1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4.2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4.3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



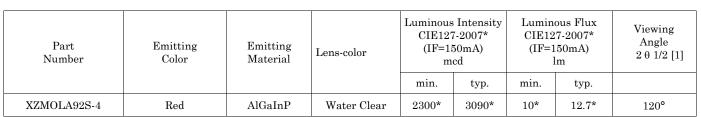
5. As silicone encapsulation is permeable to gases, some corrosive substances such as  $H_2S$  might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

Nov 15,2013 XDSB7604 V1-Z Layout: Maggie L.



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#### Notes:

- 1.  $\theta$  1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 2. Luminous intensity / luminous flux: +/-15%.
- 3. LEDs are binned according to their luminous flux.
- $\boldsymbol{^*}$  Luminous intensity / luminous flux value is in accordance with CIE127-2007 standards.

# Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Value	Unit
Power Dissipation	PD	450	mW
Junction Temperature [1]	TJ	110	°C
Operating Temperature	Тор	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	°C
DC Forward Current[1]	IF	150	mA
Peak Forward Current [3]	IFM	270	mA
Reverse Voltage	VR	5	V
Thermal Resistance [1] (Junction/ambient)	Rth j-a	180	°C/W
Thermal Resistance [1] (Junction/solder point)	Rth j-S	50	°C/W
Electrostatic Discharge Threshold (HBM)		8000	V

### Notes:

# Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	Value	Unit
Wavelength at peak emission CIE127-2007* IF=150mA [Typ.]	λpeak	640*	nm
Dominant Wavelength CIE127-2007* IF=150mA [Typ.]	λdom [1]	625*	nm
Spectral Line Half-width IF=150mA [Typ.]	$ riangle \lambda$	25	nm
Forward Voltage IF=150mA [Min.]		2.0	V
Forward Voltage IF=150mA [Typ.]	VF [2]	2.5	
Forward Voltage IF=150mA [Max.]		3.0	
Allowable Reverse Current [Max.]	IR	85	mA
Temperature coefficient of $\lambda$ peak IF=150mA, -10°C $\leq$ T $\leq$ 100°C [Typ.]	TCλpeak	0.11	nm/°C
Temperature coefficient of $\lambda$ dom IF=150mA, -10°C $\leq$ T $\leq$ 100°C [Typ.]	TCλdom	0.09	nm/°C
Temperature coefficient of VF I <sub>F</sub> =150mA, -10°C≤ T≤100°C [Typ.]	TCv	-2.5	mV/°C

#### Notes

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<sup>1.</sup>Results from mounting on PC board FR4(pad size≥70mm²), mounted on pc board-metal core PCB is recommend

for lowest thermal Resistance.

<sup>2.1/10</sup> Duty Cycle, 0.1ms Pulse Width.

<sup>1.</sup> The dominant Wavelength ( $\lambda d$ ) above is the setup value of the sorting machine. (Tolerance  $\lambda d$ :  $\pm 1 nm$ .)

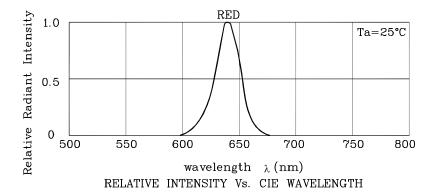
<sup>2.</sup> Forward Voltage: +/-0.1V.

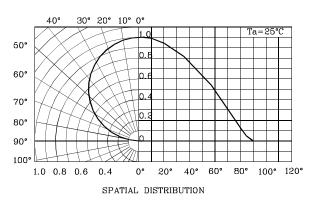
<sup>\*</sup> Wavelength is in accordance with CIE127-2007 standards.

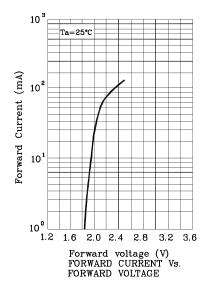


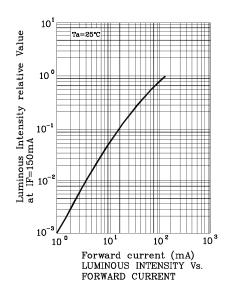


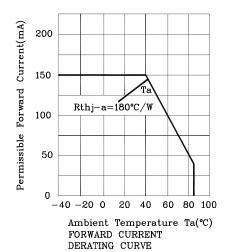
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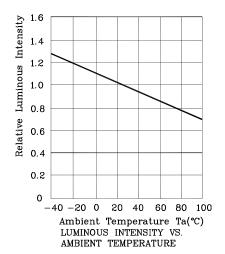










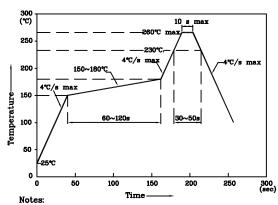






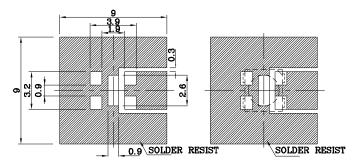
# LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)



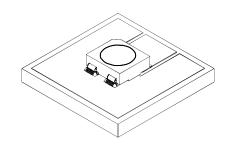
- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions

# **❖** Recommended Soldering Pattern

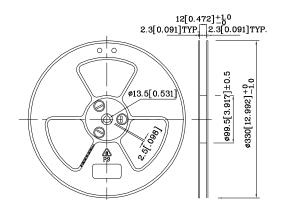


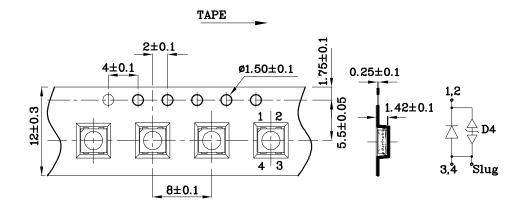
# **❖** Tape Specification (Units: mm)

❖ The device has a single mounting surface. The device must be mounted according to the specifications.

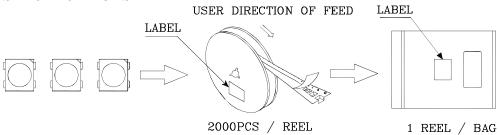


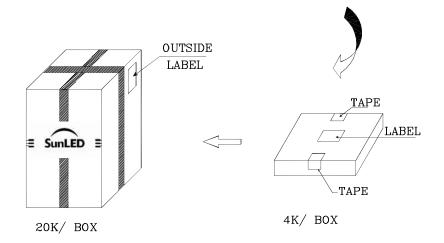
### **❖** Reel Dimension

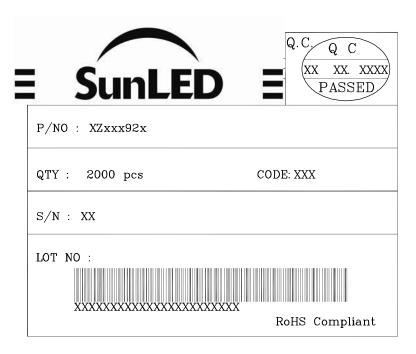




#### PACKING & LABEL SPECIFICATIONS







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